BGA Heat Sink - High Performance ASIC Cooling





ATS Part#:

Description:

ATS-56009-C1-R0

58.00 x 30.00 x 9.00 mm BGA Heat Sink - High Performance ASIC Cooling

Heat Sink Type: Heat Sink Attachment: Equivalent Part Number: ATS-56009-C3-R0

ASIC Cooling **Thermal Tape**

*Image above is for illustration purpose only.

Features & Benefits

- maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling .
- Designed specifically for ASIC package and their unique cooling requirements •
- Comes preassembled with high performance thermal interface material •

Thermal Performance

		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	4.8 °C/W	3.9 °C/W	3.1 °C/W	2.7 °C/W	2.4 °C/W	2.3 °C/W	2.2 °C/W
	Ducted Flow	2.4	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	тім	Finish
	58.00 mm	30.00 mm	9.00 mm	44.3 mm	T412	BLACK-ANODIZED
	 Dimension ATS-5600 (Saint-Go Thermal papplicatio ATS rese performar ATS certifiered 	rves the right to upd	neight from the botto of heat sink assemb e provided for refere ate or change its pro	ly with an equivalen ence only. Actual pe oducts without notice S-6 and REACH cor	t thermal	interface material e may vary by
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For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.

